

Application

- $\cdot \, \text{Motor drive}$
- · Inverter, Converter
- \cdot Photovoltaics, wind power generation.
- · Induction heating equipment.

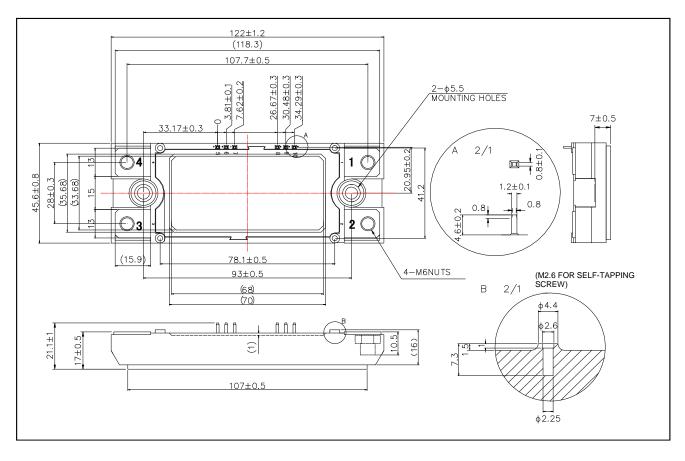
Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

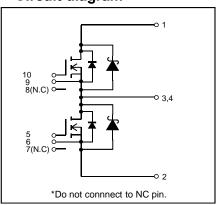
Construction

This product is a half bridge module consisting of SiC-UMOSFET and SiC-SBD from ROHM.

•Dimensions & Pin layout (Unit : mm)



•Circuit diagram



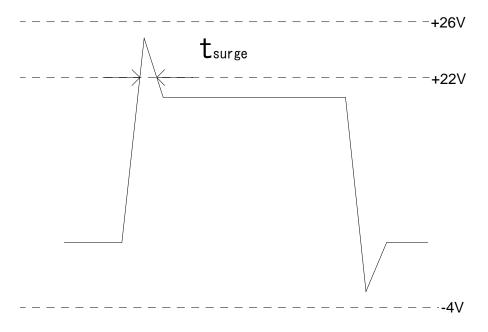
• Absolute maximum ratings $(T_j = 25^{\circ}C)$

Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	V _{DSS}	G-S short	1200		
Gate-source voltage(+)	- V _{GSS}		22	V	
Gate-source voltage(-)	V GSS	D-S short	-4	v	
G - S Voltage (t _{surge} <300ns)	V _{GSSsurge}		-4 to 26		
Drain current *1	I _D	DC (T _c =60°C)	180		
Drain current	I _{DRM}	Pulse (T _c =60°C) 1ms * ²	360		
	I _S	DC (T _c =60°C) V _{GS} =18V	180	А	
Source current *1	I _{SRM}	Pulse (T _c =60°C) 1ms V _{GS} =18V $*^2$	360		
		Pulse (T _c =60°C) 10 μ s V _{GS} =0V * ²	360		
Total power disspation * ³	Ptot	T _c =25°C	880	W	
Max Junction Temperature	T _{jmax}		175		
Junction temperature	T _{jop}		-40 to150	°C	
Storage temperature	T _{stg}		-40 to125		
Isolation voltage * ⁴	Visol	Terminals to baseplate, f=60Hz AC 1min.	2500	Vrms	
Mounting torque		Main Terminals : M6 screw	4.5	N·m	
Mounting torque	_	Mounting to heat shink : M5 screw	3.5		

(*1) Case temperature (T_c) is defined on the surface of base plate just under the chips.

(*2) Repetition rate should be kept within the range where temperature rise if die should not exceed $T_{jmax.}$ (*3) T_j is less than 175°C

Example of acceptable VGS waveform



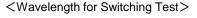
•Electrical characteristics (T_i=25°C)

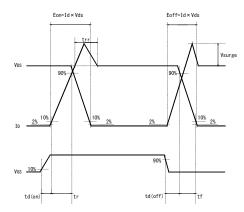
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
	V _{DS(on)}		T _j =25°C	-	1.8	2.6	V
Static drain-source on-state voltage		I _C =180A, V _{GS} =18V	T _j =125°C	-	2.7	-	
voltage			T _j =150°C	-	3.1	4	
Drain cutoff current	I _{DSS}	V _{DS} =1200V, V _{GS} =0V	-	-	2	mA	
		V _{GS} =0V, I _S =180A	T _j =25°C	-	2.1	2.6	
			T _j =125°C		2.6	-	
Source drain voltage	V		T _j =150°C	-	2.8	4.3	V
Source-drain voltage	V _{SD}		T _j =25°C	-	1.4	-	V
		V _{GS} =18V, I _S =180A	T _j =125°C		1.9		
			T _j =150°C	-	2	-	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =10V, I _D =50mA	2.7	-	5.6	V	
	I _{GSS}	V _{GS} =22V, V _{DS} =0V		-	-	0.5	μΑ
Gate-source leakage current		V_{GS} = -6V, V_{DS} =0V	-0.5	-	-		
	t _{d(on)}	$V_{GS(on)}$ =18V, $V_{GS(off)}$ = -2V * ⁴		-	50	-	ns
	t _r	V _{DS} =600V	-	70	-		
Switching characteristics	t _{rr}	I _D =180A	-	35	-		
	t _{d(off)}	$R_{G(on)}$ =8.2 Ω , $R_{G(off)}$ =4.	-	165	-		
	t _f	inductive load	-	50	-		
Input capacitance	Ciss	V _{DS} =10V, V _{GS} =0V,200	-	9	-	nF	
Gate Registance	R _{Gint}	T _j =25°C		-	1.4	-	Ω
Stray Inductance	Ls				25.0	-	nH
Creepage Distance	-	Terminal to heat sink			11.5	-	mm
		Terminal to terminal			19.0	-	mm
Clearance Distance	-	Terminal to heat sink			9.5	-	mm
Clearance Distance		Terminal to terminal			13.0	-	mm
Junction-to-case thermal	R _{th} (j-c)	UMOSFET (1/2 module) * ⁵		-	-	0.17	°C/W
resistance		SBD (1/2 module) *5	-	-	0.21	0/00	
Case-to-heat sink Thermal resistance	R _{th} (c-f)	Case to heat sink, per Thermal grease applie	-	0.035	-	°C/W	

(*4) In order to prevent self turn-on, it is recommended to apply negative gate bias.

(*5) Measurement of Tc is to be done at the point just under the chip.

- (*6) Typical value is measured by using thermally conductive grease of λ =0.9W/(m · K).
- (*7) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- (*8) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.





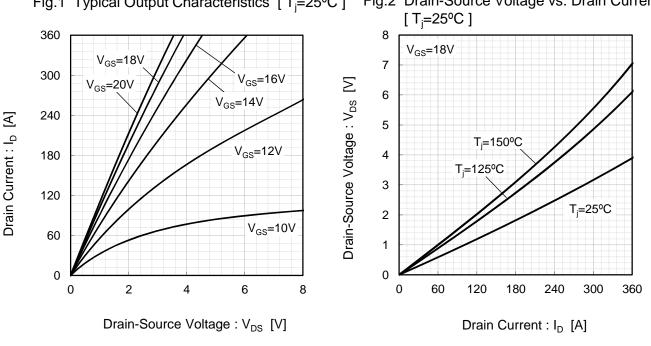
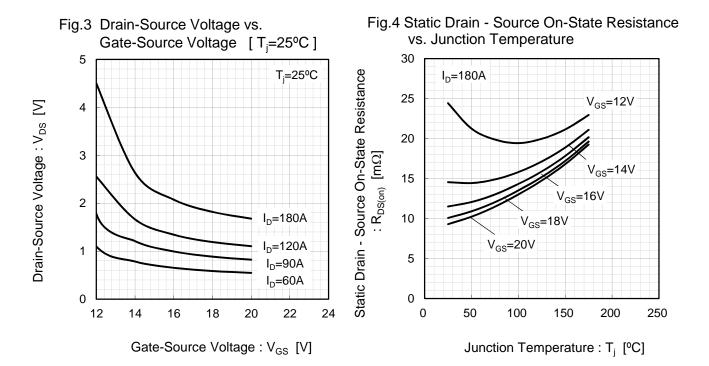


Fig.1 Typical Output Characteristics [Tj=25°C] Fig.2 Drain-Source Voltage vs. Drain Current



www.rohm.com © 2015 ROHM Co., Ltd. All rights reserved.

ROHM 20.Aug.2019 - Rev.002

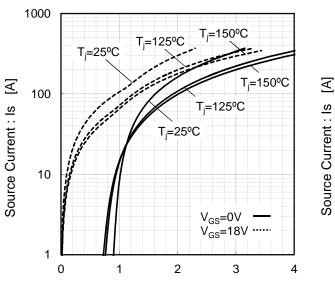
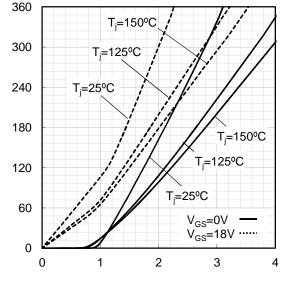


Fig.5 Forward characteristic of Diode

Fig.6 Forward characteristic of Diode

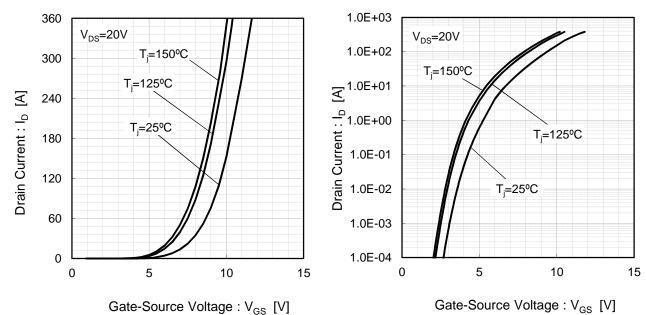


Source-Drain Voltage : V_{SD} [V]

Source-Drain Voltage : V_{SD} [V]

Fig.7 Drain Current vs. Gate-Source Voltage

Fig.8 Drain Current vs. Gate-Source Voltage



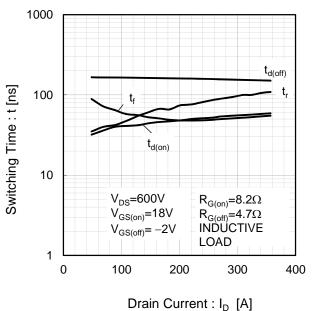
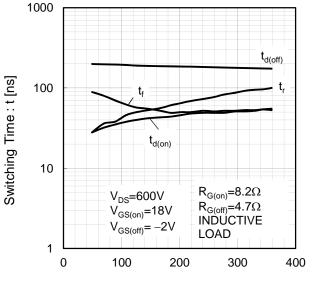


Fig.9 Switching Characteristics [T_j=25°C]

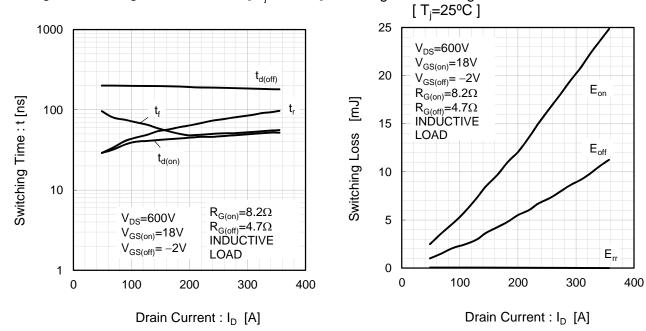
Fig.10 Switching Characteristics [T_i=125°C]

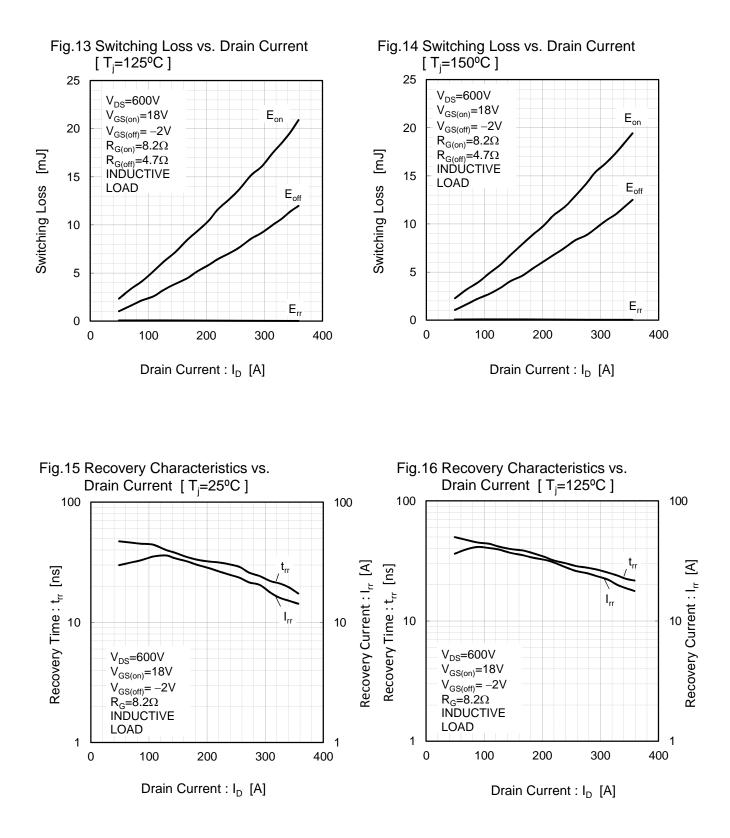


Drain Current : I_D [A]

Fig.12 Switching Loss vs. Drain Current

Fig.11 Switching Characteristics [T_i=150°C]





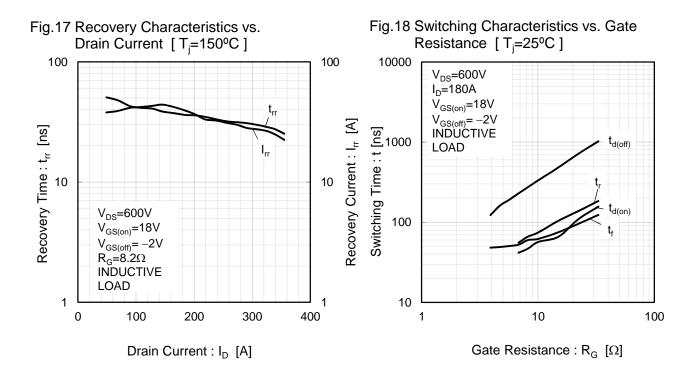
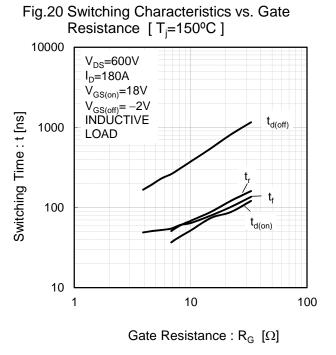


Fig.19	Switching Characteristics vs. Gate Resistance [T _i =125ºC]
10000	
Switching Time : t [ns] 001 002	$V_{DS}=600V$ $I_{D}=180A$ $V_{GS(on)}=18V$ $V_{GS(off)}=-2V$ INDUCTIVE LOAD $t_{d(off)}$ t_{r}
Switching	t _{d(on)}

10

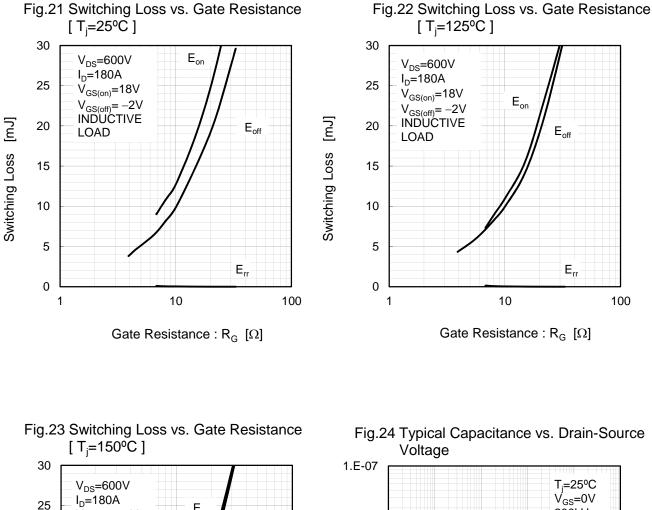
Gate Resistance : R_G [Ω]



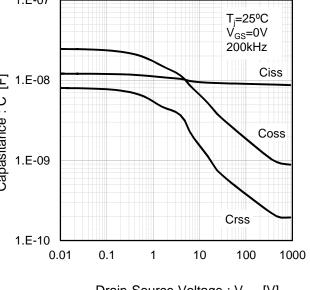
10

1

100

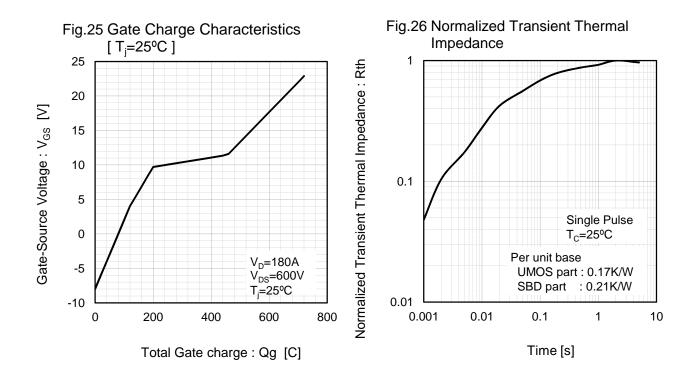


 E_{on} V_{GS(on)}=18V V_{GS(off)}= -2V INDUCTIVE E 20 1.E-08 E_{off} LOAD Capasitance : C 15 10 1.E-09 5 Err 0 1.E-10 10 0.01 1 100 Gate Resistance : R_G [Ω]



Drain-Source Voltage : V_{DS} [V]

Switching Loss [mJ]





	Notes
1)	The information contained herein is subject to change without notice.
2)	Before you use our Products, please contact our sales representative and verify the latest specifications.
3)	Although ROHM is continuously working to improve product reliability and quality, semicon ductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
4)	Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The periphera conditions must be taken into account when designing circuits for mass production.
5)	The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly any license to use or exercise intellectual property or other rights held by ROHM or any othe parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
6)	The Products specified in this document are not designed to be radiation tolerant.
7)	For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.
8)	Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
9)	ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
10)	ROHM has used reasonable care to ensure the accuracy of the information contained in thi document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
11)	Please use the Products in accordance with any applicable environmental laws and regulations such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
12)	When providing our Products and technologies contained in this document to other countries you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
13)	This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

General Precaution

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in an y way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this docume nt is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Discrete Semiconductor Modules category:

Click to view products by ROHM manufacturer:

Other Similar products are found below :

<u>M252511FV</u>	DD260N12K-A	DD380N16A	DD89N1600K-	A APT2X21D	<u>C60J</u> <u>APT58M</u>	80J <u>B522F-2-Y</u>	EC MSTC90-	16 ND104N16K
25.163.0653.1	25.163.2453.0	25.163.4253.0	25.190.2053.0	25.194.3453.0	25.320.4853.1	25.320.5253.1	25.326.3253.1	25.326.3553.1
25.330.1653.1	25.330.4753.1	25.330.5253.1	25.334.3253.1	25.334.3353.1	25.350.2053.0	25.352.4753.1	25.522.3253.0	<u>T483C</u> <u>T484C</u>
<u>T485F</u> <u>T485</u>	H <u>T512F-YEB</u>	T513F T514F	<u>T554</u> <u>T612FSE</u>	25.161.3453.0	25.179.2253.0	25.194.3253.0	25.325.1253.1	25.326.4253.1
25.330.0953.1	25.332.4353.1	25.350.1653.0	25.350.2453.0	25.352.1453.0	25.352.1653.0	25.352.2453.0	25.352.5453.1	25.522.3353.0
25.602.4053.0)							